PCB JACK Specification
1. Insulation Resistance: 500MΩ MIN @ 500 VDC
2. Withstanding Voltage: AC1000V 50Hz or 60Hz 1min.
3. Durability: 600 Mating Cycles MIN.
4. Gold Plating: (Gold Flash: 1.5; 3; 6; 15; 30; 50) μ inch
5. (1) Storage: -40°C to +85°C
   (2) Operation: -40°C to +85°C
   (3) Wave solder temperature: 230°C to 250°C, 5~10 Sec.
6. UL certification: file number E321120
7. Tolerances Unless Otherwise Specified
   .0±0.25 .00±0.20 .000±0.05

SUGGESTED PCB LAYOUT
(TOP VIEW)